## FEATURES

Amplitude settling time: 200 ns
Excellent wideband rejection: $\geq 30 \mathrm{~dB}$
Single-chip replacement for mechanically tuned designs
32-lead, $5 \mathrm{~mm} \times 5 \mathrm{~mm}$, RoHS compliant LFCSP package

## APPLICATIONS

Test and measurement equipment
Military radar and electronic warfare (EW)/electronic countermeasures (ECM)
Satellite communications (SATCOM) and space
Industrial and medical equipment

## GENERAL DESCRIPTION

The HMC892ALP5E is a tunable band-pass filter that features a user selectable pass-band frequency. The 3 dB filter bandwidth is approximately $8.7 \%$. The 20 dB filter bandwidth is approximately $23.8 \%$. The center frequency can be varied between 3.45 GHz and 6.25 GHz by applying an analog tuning voltage between 0 V and 14 V .

## FUNCTIONAL BLOCK DIAGRAM



Figure 1.

This tunable filter can be used as a smaller alternative to physically large switched filter banks and cavity tuned filters. The HMC892ALP5E has excellent microphonics due to the monolithic design and provides a dynamically adjustable solution in advanced communications applications.

## TABLE OF CONTENTS



## REVISION HISTORY

9/2018-Revision 0: Initial Version
Typical Performance Characteristics ..... 6
Theory of Operation .....  9
Applications Information ..... 10
Typical Application Circuit. ..... 10
Evaluation PCB Information ..... 10
Outline Dimensions ..... 11
Ordering Guide ..... 11in Configuration and Function Descriptions5

## SPECIFICATIONS

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{FCTL}}=\mathrm{V}_{\text {BWCTL }}$, unless otherwise noted.
Table 1.

| Parameter | Min | Typ | Max | Unit | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| FREQUENCY RANGE Center (fecnter) | 3.45 |  | 6.25 | GHz |  |
| ```BANDWIDTH 3dB 3dB Bandwidth Control, VBwctL``` |  | $\begin{aligned} & 8.7 \\ & 3 \end{aligned}$ |  | $\begin{aligned} & \% \\ & \% \end{aligned}$ | Percent change of bandwidth over fcenter, as $V_{\text {Bwctl }}$ changes |
| REJECTION <br> Low-Side <br> High-Side <br> Re-Entry |  | $\begin{aligned} & 0.89 \times \mathrm{f}_{\text {CENTER }} \\ & 1.13 \times \mathrm{f}_{\mathrm{CENTER}} \\ & 5.70 \times \mathrm{f}_{\mathrm{CENTER}} \end{aligned}$ |  | GHz <br> GHz <br> GHz | $\begin{aligned} & \geq 20 \mathrm{~dB} \\ & \geq 20 \mathrm{~dB} \\ & \leq 30 \mathrm{~dB} \end{aligned}$ |
| LOSS <br> Insertion Return |  | $\begin{aligned} & 9.5 \\ & 9.6 \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |  |
| DYNAMIC PERFORMANCE <br> Maximum Input Power for Linear Operation Input Third-Order Intercept (IP3) <br> Group Delay <br> Phase Sensitivity <br> Amplitude Settling <br> Drift Rate |  | $\begin{aligned} & 32 \\ & 1.55 \\ & 3.5 \\ & 200 \\ & \\ & 0.5 \end{aligned}$ | 10 | dBm <br> dBm <br> ns <br> Radian/V <br> ns <br> $\mathrm{MHz} /{ }^{\circ} \mathrm{C}$ | Input power $\left(\mathrm{PiN}_{\mathrm{I}}\right)=20 \mathrm{dBm}$ per tone <br> Time to settle to minimum insertion loss, within $\leq 0.5 \mathrm{~dB}$ of static insertion loss |
| RESIDUAL PHASE NOISE <br> 1 MHz Offset |  | -165 |  | $\mathrm{dBc} / \mathrm{Hz}$ |  |
| TUNING <br> Voltages ( $\mathrm{V}_{\text {FCTL }}, \mathrm{V}_{\text {BWCTL }}$ ) Currents ( $\mathrm{I}_{\text {fctL }}$, $\mathrm{I}_{\mathrm{BWct}}$ ) | 0 |  | $\begin{aligned} & 14 \\ & \pm 1 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mu \mathrm{~A} \end{aligned}$ | Each pin can be driven independently Rated current for each pin |

## ABSOLUTE MAXIMUM RATINGS

Table 2.

| Parameter | Rating |
| :---: | :---: |
| Tuning |  |
| Voltages ( $\mathrm{V}_{\text {FCTL }}, \mathrm{V}_{\text {BWCTL }}$ ) | -0.5 V to +15 V |
| Currents (Ifcti, Iswcti) | $\pm 1 \mathrm{~mA}$ |
| RF Input Power | 27 dBm |
| Temperature |  |
| Operating | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Junction for 1,000,000 Mean Time to Failure (MTTF) | $175^{\circ} \mathrm{C}$ |
| Nominal Junction (Paddle Temperature $($ TPAddLE $)=85^{\circ} \mathrm{C}, \mathrm{P}_{\text {IN }}=$ 10 dBm ) | $90^{\circ} \mathrm{C}$ |
| Electrostatic Discharge (ESD)Sensitivity Rating |  |
| Human Body Model (HBM) | 1500 V |
| Field Induced Charged Device Model (FICDM) | 1250 V |
| Moisture Sensitivity Level (MSL) Rating | MSL3 |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## ESD CAUTION

|  | ESD (electrostatic discharge) sensitive device. <br> Charged devices and circuit boards can discharge <br> without detection. Although this product features <br> patented or proprietary protection circuitry, damage <br> may occur on devices subjected to high energy ESD. <br> Therefore, proper ESD precautions should be taken to <br> avoid performance degradation or loss of functionality. |
| :--- | :--- |

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



NOTES

1. NIC = NOT INTERNALLY CONNECTED. THESE PINS ARE NOT CONNECTED INTERNALLY. ALL DATA SHOW IN THIS DATA SHEET WAS MEASURED WITH THESE PINS CONNECTED TO
RF OR DC GROUND EXTERNALLY
2. EXPOSED PAD. THE PACKAGE BOTTOM HAS AN EXPOSED METAL PAD THAT MUST BE CONNECTED TO RF AND DC GROUND.

Figure 2. Pin Configuration
Table 3. Pin Function Descriptions

| Pin No. | Mnemonic | Description |
| :--- | :--- | :--- |
| 1 to 4,7 to $11,13,15$ <br> to 18,21 to 32 | NIC | Not Internally Connected. These pins are not connected internally. All data shown in this data sheet was <br> measured with these pins connected to RF or dc ground externally. |
| 5,20 | GND | Ground. These pins and exposed paddle must be connected to RF or dc ground. See Figure 5 for the <br> interface schematic. <br> Radio Frequency Input. This pin is dc-coupled and is matched to $50 \Omega$. Do not apply external voltage <br> to this pin. See Figure 3 for the interface schematic. <br> Center Frequency Control Voltage. See Figure 4 for the interface schematic. <br> 12 |
| RFIN | VFCTL | VBWCTL <br> Bandwidth Control Voltage. See Figure 7 for the interface schematic. <br> Radio Frequency Output. This pin is dc-coupled and is matched to $50 \Omega$. Do not apply external voltage <br> to this pin. See Figure 6 for the interface schematic. <br> Exposed Pad. The package bottom has an exposed metal pad that must be connected to RF and dc <br> ground. |

## INTERFACE SCHEMATICS



Figure 3. RFIN Interface Schematic


Figure 4. VFCTL Interface Schematic


Figure 6. RFOUT Interface Schematic


Figure 7. Vвwстц Interface Schematic

Figure 5. GND Interface Schematic

## TYPICAL PERFORMANCE CHARACTERISTICS



Figure 8. Insertion Loss vs. Broadband RF Frequency at Various Voltages, $V_{\text {FCTL }}=V_{\text {BWCTL }}$


Figure 9. Insertion Loss vs. RF Frequency at Various Voltages, $V_{F C T L}=V_{B W C T L}$


Figure 10. Insertion Loss vs. RF Frequency at Various Temperatures, $V_{\text {FCTL }}=$ $V_{B W C T L}=7 \mathrm{~V}$


Figure 11. Return Loss (S11 and S22) vs. Broadband RF Frequency at Various Voltages, $V_{F C T L}=V_{B W C T L}$


Figure 12. Return Loss vs. RF Frequency at Various Voltages, $V_{F C T L}=V_{B W C T L}$


Figure 13. Return Loss vs. RF Frequency at Various Temperatures, $V_{\text {FCTL }}=$
$V_{\text {BWCTL }}=7 \mathrm{~V}$


Figure 14. Center Frequency vs. $V_{\text {FCTL }}=V_{\text {BWCTL }}$ at Various Temperatures


Figure 15. 3 dB Bandwidth vs. $V_{F C T L}=V_{B W C T L}$ at Various Temperatures


Figure 16. Low-Side Rejection Ratio vs. VFCTL $=V_{B W C T L}$ at Various Temperatures


Figure 17. Insertion Loss vs. $V_{F C T L}=V_{B W C T L}$ at Various Temperatures


Figure 18. Maximum Return Loss vs. $V_{F C T L}=V_{B W C T L}$ at Various Temperatures, 2 dB Bandwidth


Figure 19. High-Side Rejection Ratio vs. $V_{F C T L}=V_{\text {BWCTL }}$ at Various Temperatures


Figure 20. Tuning Sensitivity vs. $V_{F C T L}=V_{B W C T L}$ at Various Temperatures


Figure 21. Group Delay vs. $V_{F C T L}=V_{B W C T L}$ at Various Temperatures


Figure 22. Phase Noise vs. Offset Frequency at Various Voltages, $V_{F C T L}=V_{B W C T L}$


Figure 23. Group Delay vs. RF Frequency at Various Voltages, $V_{F C T L}=V_{B W C T L}$


Figure 24. Input IP3 vs. $V_{\text {FCTL }}=V_{\text {BWCTL }}$ at Various Temperatures with an Input Power of 20 dBm


Figure 25. Phase Shift vs. Input Power at Various Voltages, $V_{F C T L}=V_{B W C T L}$
Data Sheet HMC892ALP5E

## THEORY OF OPERATION

The HMC892ALP5E is a tunable band-pass filter that features a user selectable pass-band frequency. Varying the applied analog tuning voltage between 0 V and 14 V at the $\mathrm{V}_{\text {fcti }}$ pin varies the center frequency between 3.45 GHz and 6.25 GHz . The bandwidth
of the filter is adjustable by using the $\mathrm{V}_{\text {вwсть }}$ control voltage, which varies from 0 V to 14 V . Typical operation is to tie both $\mathrm{V}_{\mathrm{FCTL}}$ and $\mathrm{V}_{\text {BWCTL }}$ control voltages together.

## APPLICATIONS INFORMATION TYPICAL APPLICATION CIRCUIT

Figure 26 shows the typical application circuit for the HMC892ALP5E. RFIN and RFOUT are dc-coupled and require external 100 pF series capacitors ( C 1 and C 2 ).


Figure 26. Typical Application Circuit

## EVALUATION PCB INFORMATION

All RF traces are routed on Layer 1 (primary side), and all other layers are ground planes that provide a solid ground for RF transmission lines, as shown in Figure 27. The top dielectric material is Rogers 4350, offering low loss performance. The preimpregnated (PREPREG) material in Layer 2 sticks the Isola 370HR with copper trace layers above and below together. Both the PREPREG material and the Isola 370 HR core layer are used to achieve required board finish thickness.


Figure 27. 4-Layer Stackup
The printed circuit board (PCB) used in the application uses radio frequency (RF) circuit design techniques. Signal lines must have a $50 \Omega$ impedance while the package ground leads and exposed pad must be connected directly to the ground plane (see Figure 28). Use a sufficient number of via holes to connect the top and bottom ground planes. The evaluation PCB shown in Figure 28 is available from Analog Devices, Inc., upon request. The HMC890ALP5E evaluation board in Figure 28 is used to evaluate the HMC892ALP5E device.

Table 4. Bill of Materials

| Item | Description |
| :--- | :--- |
| J1 to J2 | PCB mounts SRI, SMA connector |
| J3 to J4 | PCB mounts, Johnson SMA connector |
| C1, C2 | 100 pF capacitors, 0402 package |
| U1 | HMC892ALP5E |
| PCB $^{1}$ | $08-049598^{2}$ evaluation PCB |

[^0]

Figure 28. Evaluation PCB Top Layer

## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-220-WHHD-5
ure 29. 32-Lead Lead Frame Chip Scale Package [LFCS
$5 \mathrm{~mm} \times 5 \mathrm{~mm}$ Body and 0.75 mm Package Height (CP-32-12)
Dimensions shown in millimeters

## ORDERING GUIDE

| Model $^{1}$ | Temperature Range | Package Description | Package Option |
| :--- | :--- | :--- | :--- |
| HMC892ALP5E | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 32-Lead Lead Frame Chip Scale Package [LFCSP] | $\mathrm{CP}-32-12$ |
| HMC892ALP5ETR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 32-Lead Lead Frame Chip Scale Package [LFCSP] | CP-32-12 |
| EV1HMC892ALP5 |  | Evaluation PCB |  |

[^1]
## X-ON Electronics

Largest Supplier of Electrical and Electronic Components
Click to view similar products for Active Filters category:
Click to view products by Analog Devices manufacturer:
Other Similar products are found below :
VEMI256A-SD2-G4-08 HMC894LP5ETR HMC896LP4ETR HMC891LP5ETR MAX7491CEE+ MAX7413CUA+ MAX7411CUA+ MAX281AEWE + MAX280EPA+ MAX274AENG + LTC1064-3CSW\#PBF LTC1060ACN\#PBF LTC1069-1IS8\#PBF LTC11646CSW\#PBF LTC1064-2CSW\#PBF LTC1569CS8-7\#PBF LTC1164ACSW\#PBF LTC1067-50CS\#PBF LTC1164-6CN\#PBF
LTC1059CN\#PBF LTC1069-1CN8\#PBF LTC1069-7IS8\#PBF LTC1069-6CS8\#PBF LTC1562IG-2\#PBF LTC1164-5CSW\#PBF LTC1566-
1CS8\#PBF LTC1064-7CN\#PBF LTC1063CN8\#PBF LTC1062CN8\#PBF LTC6603IUF\#PBF LTC1061ACN\#PBF LTC1061CN\#PBF
LTC1264CN\#PBF LTC1562ACG\#PBF LTC1562AIG\#PBF LTC1064-3CN\#PBF HMC890ALP5E HMC892ALP5E HMC891ALP5E
HMC882ALP5E HMC881ALP5E ADMV8420ACPZ ADMV8432ACPZ HMC881LP5ETR HMC882LP5ETR HMC1000LP5ETR
LTC1068IN\#PBF LTC1566-1IS8\#PBF LTC1569IS8-6\#PBF LTC1069-1CS8\#PBF


[^0]:    ${ }^{1}$ Circuit board material is Arlon 25FR or Rogers 25FR.
    ${ }^{2}$ 08-049598 is the raw bare PCB identifier. Reference EV1HMC891ALP5 when ordering the complete evaluation PCB.

[^1]:    ${ }^{1}$ All models are RoHS compliant parts.

